



PCB Layout

- Performance characteristics:
- Main body part material
Insulator: PA66,Nature,UL94V-0
Contact terminal: Brass,1.27 μm Ni under plated, outer plating Sn 3 μm Min.
 - Electrical requirements:
Current rating: 10 A
Contact resistance: ≤20 mΩ
Insulation resistance: ≥1000 MΩ
Withstanding voltage: 1500 Vr.m.s, 1mA, 60s
 - Environment specification
Working temperature: -40°C~+105°C
 - Packing & storing
Method of packing: Plastic bag, outer box
Storing condition: Temperature of -10°C~+40°C below 80% relative humidity
 - Style of installation: Solder PCB installation
 - To prevent the pollution of the environment product info
RoHS agreement: In line with the european union RoHS.

Unless otherwise specified tolerance:

X.	±0.50	X.°	±3°
.X	±0.38	.X°	±2°
.XX	±0.25		

Mark	NO.	File NO.	Signature	Date
DRAW				Tim Lv 2017.11.25
CHK				Tim20183.4.13
MAN				
STD				Spring2018.4.13
APP				Alan2018.4.13

5.08mm Pitch wafer
straight male

1345-041-8B-D

SLO. 1345.008			
Projection	Rev.	Weight	Scale
	B0		
All Dimensions in mm		Sheet 1 of 1	
SHINNING SHENZHEN SHINNING ELECTRONIC CO.,LTD.			